MMVL2101T1

Preferred Device

Silicon Tuning Diode

These devices are designed in the popular Plastic Surface Mount Package for high volume requirements of FM Radio and TV tuning and AFC, general frequency control and tuning applications. They provide solid–state reliability in replacement of mechanical tuning methods.

Features

- High Q
- Controlled and Uniform Tuning Ratio
- Standard Capacitance Tolerance 10%
- Complete Typical Design Curves
- Pb-Free Package is Available

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Continuous Reverse Voltage	V _R	30	Vdc
Peak Forward Current	I _F	200	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR–5 Board, T _A = 25°C (Note 1) Derate above 25°C	P _D	200 1.57	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	635	°C/W
Junction and Storage Temperature	T _J , T _{stg}	150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. FR-4 Minimum Pad



ON Semiconductor®

http://onsemi.com

30 VOLTS VOLTAGE VARIABLE CAPACITANCE DIODE





PLASTIC SOD-323 CASE 477 STYLE 1

MARKING DIAGRAM



4G = Device Code M = Date Code* ■ = Pb-Free Package

(Note: Microdot may be in either location)
*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
MMVL2101T1	SOD-323	3000 / Tape & Reel
MMVL2101T1G	SOD-323 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage (I _R = 10 μAdc)	V _{(BR)R}	30	-	-	Vdc
Reverse Voltage Leakage Current (V _R = 25 Vdc, T _A = 25°C)	I _R	-	-	0.1	μAdc
Diode Capacitance Temperature Coefficient (V _R = 4.0 Vdc, f = 1.0 MHz)	TC _C	-	280	-	ppm/°C

	C _T , Diode Capacitance V _R = 4.0 Vdc, f = 1.0 MHz pF		Q, Figure of Merit V _R = 4.0 Vdc, f = 50 MHz	TR, Tuning Ratio C ₂ /C ₃₀ f = 1.0 MHz			
Device	Min	Nom	Max	Тур	Min	Тур	Max
MMVL2101T1	6.1	6.8	7.5	450	2.5	2.7	3.2

PARAMETER TEST METHODS

1. C_T, DIODE CAPACITANCE

 $(C_T = C_C + C_J)$. C_T is measured at 1.0 MHz using a capacitance bridge (Boonton Electronics Model 75A or equivalent).

2. TR, TUNING RATIO

TR is the ratio of C_T measured at 2.0 Vdc divided by C_T measured at 30 Vdc.

3. Q, FIGURE OF MERIT

Q is calculated by taking the G and C readings of an admittance bridge at the specified frequency and substituting in the following equations:

$$Q = \frac{2\pi fC}{G}$$

(Boonton Electronics Model 33AS8 or equivalent). Use Lead Length $\approx 1/16$ °.

4. TC_C, DIODE CAPACITANCE TEMPERATURE COEFFICIENT

 TC_C is guaranteed by comparing C_T at $V_R = 4.0$ Vdc, f = 1.0 MHz, $T_A = -65$ °C with C_T at $V_R = 4.0$ Vdc, f = 1.0 MHz, $T_A = +85$ °C in the following equation, which defines TC_C :

$$\mathsf{TC}_C \, = \, \left| \frac{\mathsf{C}_T(+ \, 85^\circ C) - \mathsf{C}_T(-65^\circ C)}{85 \, + \, 65} \right| \cdot \, \frac{10^6}{\mathsf{C}_T(25^\circ C)}$$

Accuracy limited by measurement of C_T to ± 0.1 pF.

MMVL2101T1

TYPICAL DEVICE CHARACTERISTICS

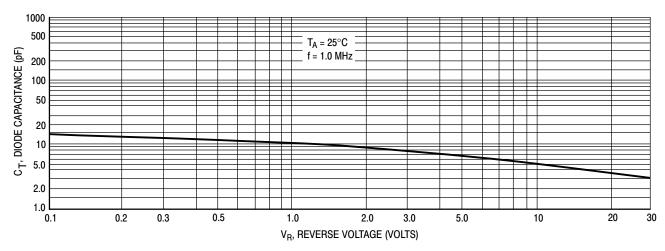


Figure 1. Diode Capacitance versus Reverse Voltage

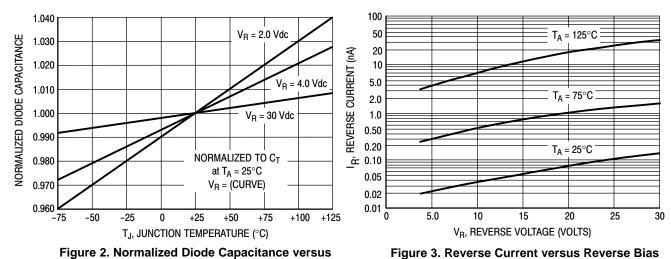


Figure 2. Normalized Diode Capacitance versus Junction Temperature

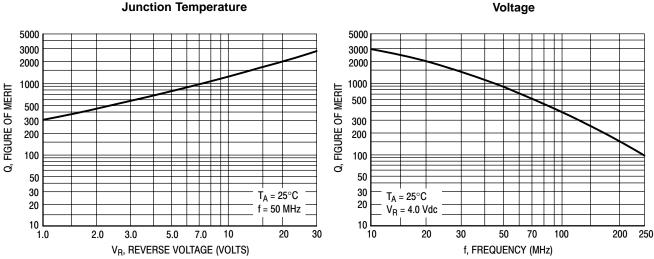


Figure 4. Figure of Merit versus Reverse Voltage

Figure 5. Figure of Merit versus Frequency

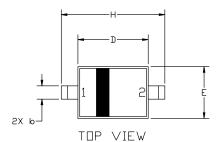






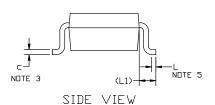
SOD-323 1.70x1.25x0.85 **CASE 477 ISSUE K**

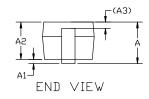
DATE 11 MAR 2024



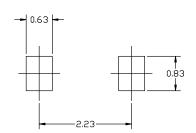
NOTES:

- 1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M, 2018.
- CONTROLLING DIMENSION: MILLIMETERS. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH 3. SOLDER PLATING.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
 DIMENSION L IS MEASURE FROM END OF RADIUS.





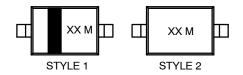
DIM	MI	LLIMETE	RS
ויונע	MIN.	N□M.	MAX.
Α	0.80	0.90	1.00
A1	0.00	0.05	0.10
A2	0.75	0.85	0.95
А3	0.15 (REF)		
b	0.25	0.32	0.4
C	0.09	0.12	0.18
D	1.60	1.70	1.80
Ε	1.15	1.25	1.35
Н	2.30	2.50	2.70
L	0.08		
L1	0.40 (REF)		



RECOMMENDED MOUNTING FOOTPRINT

*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques
Reference manual, SDLDERRM/D.

GENERIC MARKING DIAGRAM*



XX = Specific Device Code M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

STYLE 2: NO POLARITY PIN 1. CATHODE (POLARITY BAND) 2. ANODE

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DESCRIPTION:	SOD-323 1.70x1.25x0.85		PAGE 1 OF 1	

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